



80V 175°C DUAL CHANNEL ENHANCEMENT MODE MOSFET PowerDI5060-8

Product Summary

BV _{DSS}	Rds(on) Max	I _D Max T _C = +25°C	
80V	$26m\Omega$ @ $V_{GS} = 10V$	28.5A	
	45mΩ @ V _{GS} = 4.5V	21A	

Description and Applications

This new generation MOSFET features low on-resistance and fast switching, making it ideal for high efficiency power management applications.

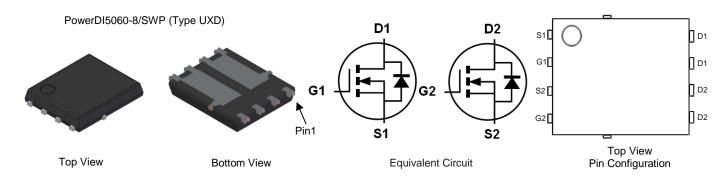
- DC-DC Converters
- Motor

Features and Benefits

- Rated to +175°C Ideal for High Ambient Temperature Environments
- 100% Unclamped Inductive Switching (UIS) Test in Production Ensures More Reliable and Robust End Application
- Low Input Capacitance
- Fast Switching Speed
- Wettable Flank for Improved Optical Inspection
- Additional Tin-Plated on Sidewall Pads for Optical Solder Inspection
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please contact us or your local Diodes representative. https://www.diodes.com/quality/product-definitions/

Mechanical Data

- Case: PowerDI[®]5060-8
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Annealed over Copper Leadframe.
 Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.097 grams (Approximate)



Ordering Information (Note 4)

Part Number	Case	Packaging
DMTH8030LPDW-13	PowerDI5060-8/SWP (Type UXD)	2500/Tape & Reel

Notes:

- 1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/

PowerDI is a registered trademark of Diodes Incorporated.



Marking Information



☐ Hanufacturer's Marking☐ H8030LPDW = Product Type Marking Code☐ YYWW = Date Code Marking YY = Year (ex: 21 = 2021)WW = Week (01 to 53)

Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Drain-Source Voltage	VDSS	80	V	
Gate-Source Voltage	Vgss	±20	V	
Continuous Drain Current, V _{GS} = 10V (Note 6) $ T_C = +25^{\circ}C $ $ T_C = +100^{\circ}C $		lσ	28.5 20	А
Maximum Body Diode Forward Current	Is	29	A	
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)	I _{DM}	113.5	A	
Pulsed Body Diode Forward Current (10µs Pulse, Tc = +25°C, Package L	Ism	113.5	Α	
Avalanche Current, L = 0.3mH	las	12.5	Α	
Avalanche Energy, L = 0.3mH	Eas	23.4	mJ	

Thermal Characteristics

Characteristic		Symbol	Value	Unit
Thermal Resistance, Junction to Ambient (Note 5)		Reja	48	°C/W
Total Power Dissipation $T_A = +25^{\circ}C$		PD	3.1	W
Thermal Resistance, Junction to Case (Note 6)	Rejc	3.7	°C/W	
Total Power Dissipation $T_C = +25^{\circ}C$		P _D	41	W
Operating and Storage Temperature Range		TJ, TSTG	-55 to +175	°C

Notes:

^{5.} Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.6. Thermal resistance from junction to solder point (on the exposed drain pin).



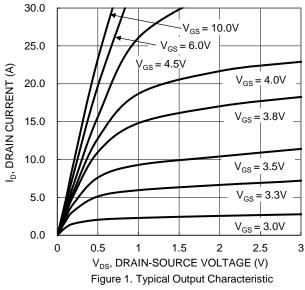
Electrical Characteristics (@T_C = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)							
Drain-Source Breakdown Voltage	BVDSS	80	_	_	V	$V_{GS} = 0V$, $I_D = 1mA$	
Zero Gate Voltage Drain Current	IDSS	_	_	1	μA	V _{DS} = 64V, V _{GS} = 0V	
Gate-Source Leakage	I _{GSS}	_	_	±100	nA	$V_{GS} = \pm 20V$, $V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)	ON CHARACTERISTICS (Note 7)						
Gate Threshold Voltage	Vgs(th)	1.3	_	2.5	V	$V_{DS} = V_{GS}$, $I_D = 250\mu A$	
Static Drain-Source On-Resistance	D	_	20	26	mΩ	$V_{GS} = 10V, I_D = 10A$	
Static Drain-Source On-Resistance	R _{DS(ON)}	_	29	45	11122	V _{GS} = 4.5V, I _D = 5A	
Diode Forward Voltage	VsD	_	0.9	1.2	V	V _G S = 0V, I _S = 10A	
DYNAMIC CHARACTERISTICS (Note 8)	DYNAMIC CHARACTERISTICS (Note 8)						
Input Capacitance	Ciss	-	631	_		V _{DS} = 40V, V _{GS} = 0V, f = 1.0MHz	
Output Capacitance	Coss	_	200	_	pF		
Reverse Transfer Capacitance	Crss	_	19.5	_			
Gate Resistance	Rg	_	1.1	_	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1.0MHz$	
Total Gate Charge (V _{GS} = 4.5V)	Qg	_	5.4	_			
Total Gate Charge (V _{GS} = 10V)	Qg	_	10.4	_	nC	Vps = 40V. Ip = 7.5A	
Gate-Source Charge	Qgs	_	1.8	_	110	VDS = 40V, ID = 7.5A	
Gate-Drain Charge	Qgd	_	2.4	_			
Turn-On Delay Time	t _{D(ON)}	_	7.1	_		V _{DD} = 40V, V _{GS} = 4.5V, R _G = 2.7Ω, I _D = 10A	
Turn-On Rise Time	t _R	_	9.7	_	no		
Turn-Off Delay Time	tD(OFF)	_	18.6	_	ns		
Turn-Off Fall Time	tF	_	8.6	_			
Body Diode Reverse Recovery Time	t _{RR}	_	28.5	_	ns	I _F = 7.5A, di/dt = 100A/μs	
Body Diode Reverse Recovery Charge	Qrr	_	21.7	_	nC	I _F = 7.5A, di/dt = 100A/μs	

Notes:

^{7.} Short duration pulse test used to minimize self-heating effect. 8. Guaranteed by design. Not subject to product testing.





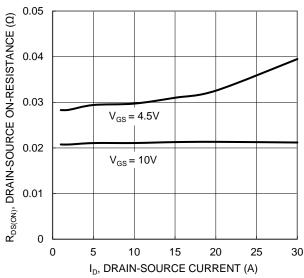


Figure 3. Typical On-Resistance vs. Drain Current and Gate Voltage

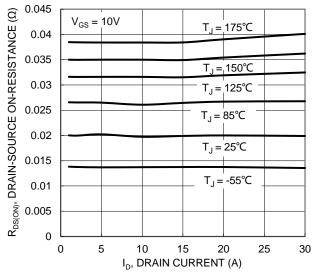


Figure 5. Typical On-Resistance vs. Drain Current and Junction Temperature

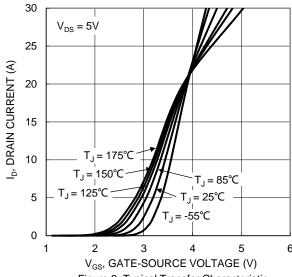


Figure 2. Typical Transfer Characteristic

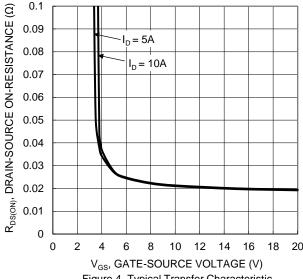


Figure 4. Typical Transfer Characteristic

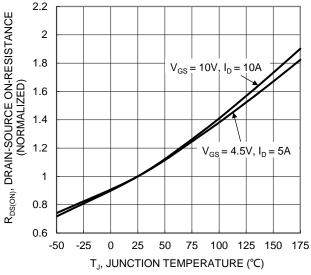


Figure 6. On-Resistance Variation with Junction Temperature



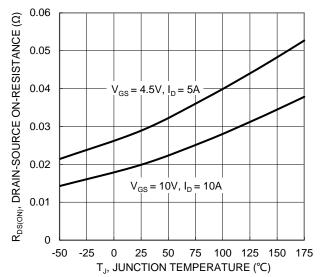


Figure 7. On-Resistance Variation with Junction Temperature

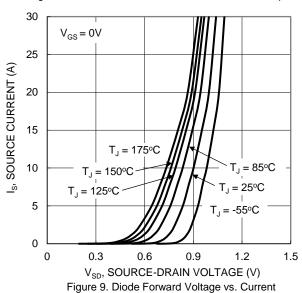


Figure 11. Gate Charge

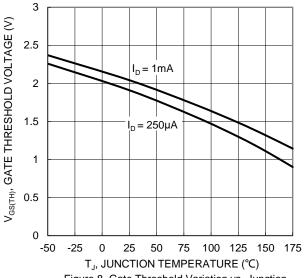
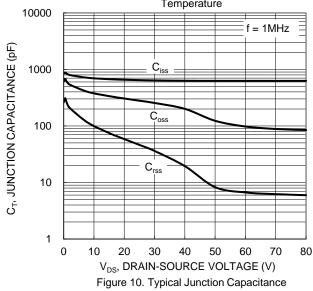
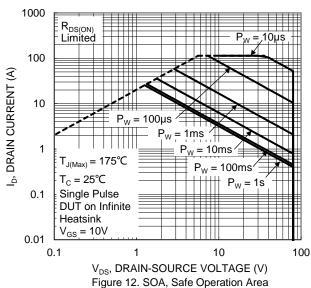


Figure 8. Gate Threshold Variation vs. Junction Temperature







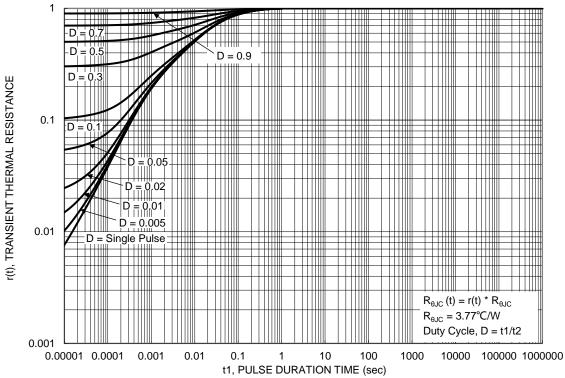


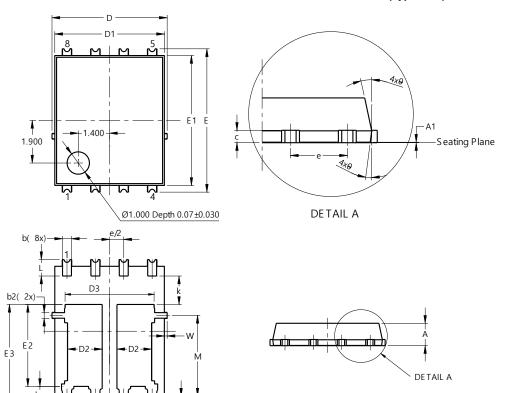
Figure 13. Transient Thermal Resistance



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI5060-8/SWP (Type UXD)



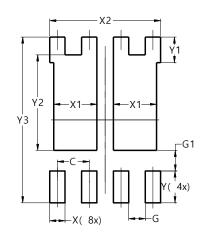
PowerDI5060-8/SWP (Type UXD)				
Dim	Min Max		Тур	
Α	0.90	1.10	1.00	
A1	0.00	0.05		
b	0.30	0.50	0.41	
b2	0.20	0.35	0.25	
b4	().25REF	-	
С	0.230	0.330	0.277	
D	5	.15 BS0	2	
D1	4.70	5.10	4.90	
D2	1.46	1.66	1.55	
D3	3.78	4.18	3.98	
Е	6	.40 BS0	\sim	
E1	5.60	6.00	5.80	
E2	3.46	3.86	3.66	
E2a	4.195	4.595	4.395	
е		.27BSC)	
k	1.05			
L	0.635	0.835	0.735	
La	0.635	0.835	0.735	
L1	0.200	0.400	0.300	
M	3.205	4.005	3.605	
W	0.025	0.225	0.125	
θ	10°	12°	11°	
θ1	6°	8°	7°	
All Dimensions in mm				

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

-b4(8x)

PowerDI5060-8/SWP (Type UXD)



Dimensions	Value		
Dilliensions	(in mm)		
С	1.270		
G	0.660		
G1	0.820		
X	0.610		
X1	1.720		
X2	4.420		
Y	1.270		
Y1	1.020		
Y2	3.810		
Y3	6.610		



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DMTH8030LPDW
Document number: DS43304 Rev. 2 - 2

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